ASSOCIATION CONNECT	© Copyright 2005. IPG	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute									s Materia	als and Mf	g Informa	tion	
Supplier Infor	mation														
Company name*			Company unique ID			Ţ	Unique ID Authority					Response Date*			
nsemi												2023-06-12			
Contact Name		Title - Contact			F	Phone - Contact*					Email - Contact*				
Product-Env-Ste	wards	Product Enviro Compliance]	NA					Product-Env-Stewards@onsemi.com				
uthorized Repre	esentative*	Title - Representative			F	Phone - Representative*				Email - Representative*					
Product-Env-Stewards			Product Enviro Compliance]	NA					Product-Env-Stewards@onsemi.com			
Reque	ster Item Number	Mfr Iten	em Number Mfr Item Name				Effective Date	e Version	n N	Manufacturing Site		W	eight*	UOM	Unit Type
		FPF2165		Current Limit Load Switch			2023-06-12 TH2		TH2	2 9		44	mg	Each	
Ianufacturin	g Proccess Informati	on													
Termin	al Plating / Grid Array Mate	erial T	Terminal Base Alloy		J-STD-020 M	STD-020 MSL Rating		Peak Process Body Temperature		re Max Time at Peak Tempera		Temperatu	ature Number of Reflow Cycles		eles
Preciou Sn)	Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)		CU Alloy 1		1		260		С	30		second	s 3		
Comments															
vel 1 - maximun	n time at peak temperatur	e during so	ldering is 10-3	0 seconds											
or more informa	ation regarding material co	omposition	please refer to	page 3										·	

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier has not orditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty ri											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.6023	mg	Supplier	Silicon (Si)	7440-21-3		0.6023	mg
Die Attach	0.0776	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.0047	mg
			Supplier	Silver (Ag)	7440-22-4		0.0632	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.0047	mg
			Supplier	Misc.	Proprietary Data		0.0004	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.0047	mg
Lead Frame	4.0051	mg	Supplier	Zinc (Zn)	7440-66-6		0.005	mg
			Supplier	Iron (Fe)	7439-89-6		0.0941	mg
			Supplier	Copper (Cu)	7440-50-8		3.9027	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0033	mg
Mold Compound-Black	4.612	mg		Epoxy resin	proprietary data		0.2306	mg
			Supplier	Phenolic Resin	Proprietary Data		0.1061	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		0.2306	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0184	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.1061	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.9202	mg
Plating	0.056	mg	Supplier	Silver (Ag)	7440-22-4		0.0009	mg
			Supplier	Palladium (Pd)	7440-05-3		0.002	mg
			В	Nickel (Ni)	7440-02-0		0.052	mg
			Supplier	Gold (Au)	7440-57-5		0.0011	mg
Wire Bond - Au	0.087	mg	Supplier	Gold (Au)	7440-57-5		0.087	mg